



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-03-17	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1674954-1	<b>Amount</b>	19.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	SHIELD FINGER 2026 WITH TAPE	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0616</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	CONTACT,ST AMP,SHIELD FINGER 20				1.0	19.0	mg	
Material	2	Nickel Plate				1.0	0.3776	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	7.552E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	3.776E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	0.37647	mg	
Material	2	Gold Plate				1.0	0.01129	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	1.0	0.01125613	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	1.0	3.387E-5	mg	
Material	2	Beryllium Copper				1.0	18.61111	mg	
Substance	3	Beryllium	Supplier	7440-41-7	2.0	1.0	0.37222	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	1.0	0.00186111	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	1.0	0.00372222	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.2	1.0	0.03722222	mg	
Substance	3	Silicon	Supplier	7440-21-3	0.2	1.0	0.03722222	mg	
Substance	3	Iron	Supplier	7439-89-6	0.4	1.0	0.07444444	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.00186111	mg	
Substance	3	Aluminum	Supplier	7429-90-5	0.2	1.0	0.03722222	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	1.0	1.8611E-4	mg	
Substance	3	Copper	Supplier	7440-50-8	96.649	1.0	17.98745	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.01861111	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	1.0	0.03722222	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	9.3056E-4	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	9.305555E-5	mg	